ONSEMI

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MOSFET – N-Channel, SUPERFET[®] II, Easy-Drive

600 V, 20.6 A, 190 m Ω

FCP190N60E, FCPF190N60E

Description

SUPERFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SUPERFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SUPERFET II MOSFET series.

Features

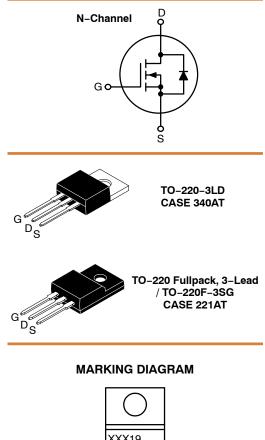
- 650 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 160 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 63 \text{ nC}$)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 178 pF)
- 100% Avalanche Tested
- An Integrated Gate Resistor
- RoHS Compliant

Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

V _{DS}	R _{DS(ON)} MAX	I _D MAX	
600 V	190 m Ω @ 10 V	20.6 A*	

*Drain current limited by maximum junction temperature.



)	
XXX19 0N60E	
AYWWZZ	

XXX190N60E	= Device Code (XXX = FCP, FCPF)
А	= Assembly Location
YWW	= Date Code (Year & Week)
ZZ	= Assembly Lot
	-

ORDERING INFORMATION

Device	Package	Shipping
FCP190N60E	TO-220	800 Units / Tube
FCPF190N60E	TO-220F	1000 Units / Tube

Symbol		Parameter	FCP190N60E	FCPF190N60E	Unit
V _{DSS}	Drain to Source Voltage		6	00	V
V _{GSS}	Gate to Source Voltage	e -DC ±20		20	V
		–AC (f > 1 Hz)	±	30	
ID	Drain Current	– Continuous (T _C = 25°C)	20.6	20.6*	А
		– Continuous (T _C = 100°C)	13.1	13.1*	
I _{DM}	Drain Current	– Pulsed (Note 1)	61.8	61.8*	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		400		mJ
I _{AR}	Avalanche Current (Note 1) 4.0		1.0	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.1		mJ
dv/dt	MOSFET dv/dt		100 20		V/ns
	Peak Diode Recovery dv/	dt (Note 3)			
PD	Power Dissipation	(T _C = 25°C)	208	39	W
		-Derate above 25°C	1.67	0.31	W/°C
T _J , T _{STG}	Operating and Storage Te	mperature Range	-55 to +150		°C
ΤL	Maximum Lead Temperat 1/8" from Case for 5 Seco		300		°C

MOSFET MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 4 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 10 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le \text{BV}_{DSS}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

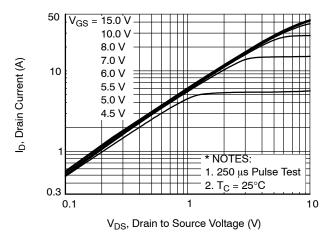
Symbol	Parameter	FCP190N60E	FCPF190N60E	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.6	3.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 10 mA, T_J = 25°C	600	-	-	V
		V_{GS} = 0 V, I _D = 10 mA, T _J = 150°C	650	-	-	
$\Delta \text{BV}_{\text{DSS}}$	Breakdown Voltage Temperature	$I_D = 10$ mA, referenced to $25^{\circ}C$	-	0.67	-	V/°C
ΔT_{J}	Coefficient					
BV_{DS}	Drain to Source Avalanche Breakdown Voltage	V_{GS} = 0 V, I _D = 20 A	-	700	_	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ
		$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	2.8	-	
I _{GSS}	Gate to Body Leakage Current	$V_{GS}=\pm 20 \text{ V}, V_{DS}=0 \text{ V}$	-	-	±100	nA
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, \ I_D = 250 \ \mu A$	2.5	-	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.16	0.19	Ω
g fs	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	20	-	S
DYNAMIC (CHARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	-	2385	3175	pF
C _{oss}	Output Capacitance		-	1795	2396	pF
C _{rss}	Reverse Transfer Capacitance		-	110	165	pF
Coss	Output Capacitance	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	42	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	-	178	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 10 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	63	82	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	10	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	24	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	5	-	Ω
SWITCHING	G CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 300 \text{ V}, I_D = 10 \text{ A}, V_{GS} = 10 \text{ V},$	-	23	56	ns
t _r	Turn-On Rise Time	R _G = 4.7 Ω (Note 4)	-	14	38	ns
t _{d(off)}	Turn-Off Delay Time]]	-	101	212	ns
t _f	Turn-Off Fall Time		-	15	40	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS					
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	20.2	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	60.6	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 10 \text{ A}$	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 10 A, dI_F/dt = 100 A/µs	-	308	-	ns
Q _{rr}	Reverse Recovery Charge	1	_	4.8	1	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS





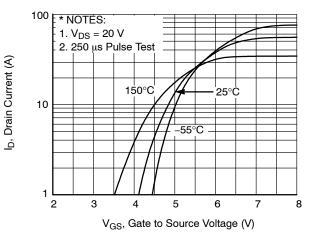


Figure 2. Transfer Characteristics

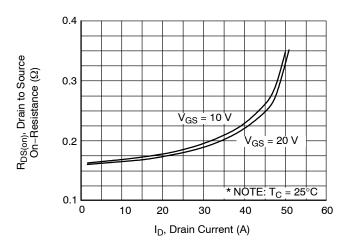


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

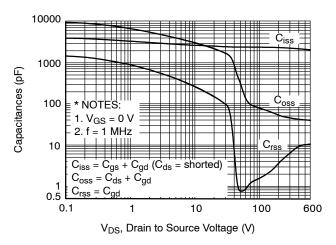


Figure 5. Capacitance Characteristics

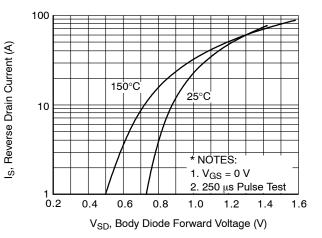


Figure 4. Body Diode Forward Voltage Variation vs. Source Current And Temperature

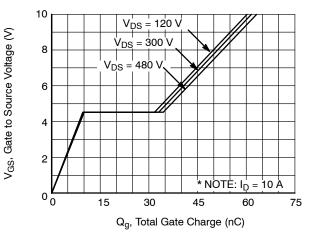
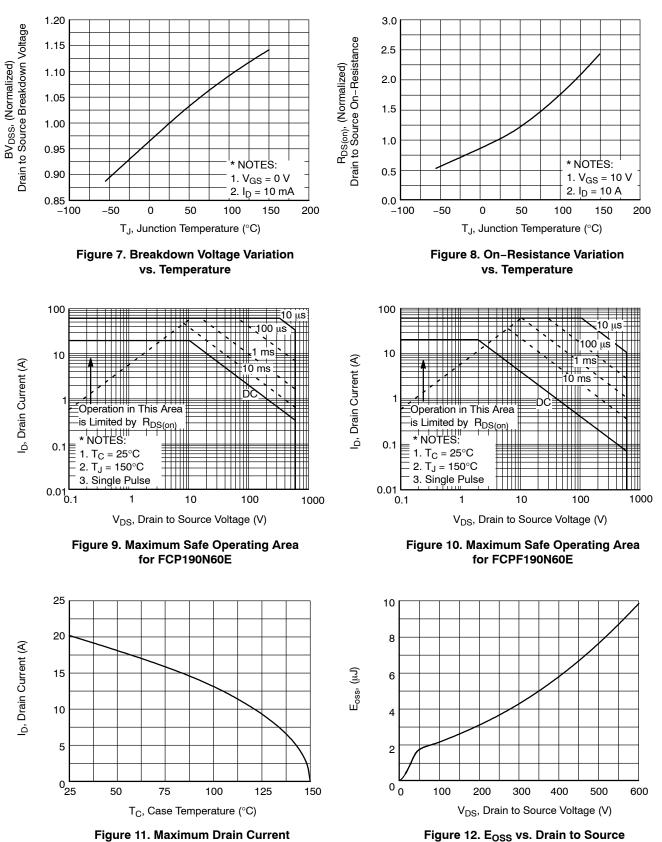


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



vs. Case Temperature

Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

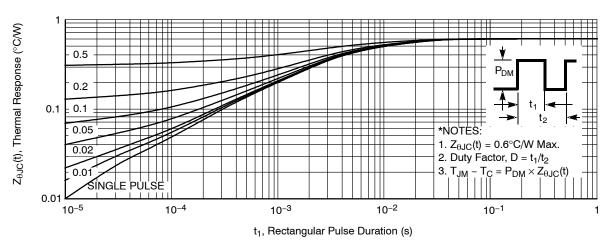


Figure 13. Transient Thermal Response Curve for FCP190N60E

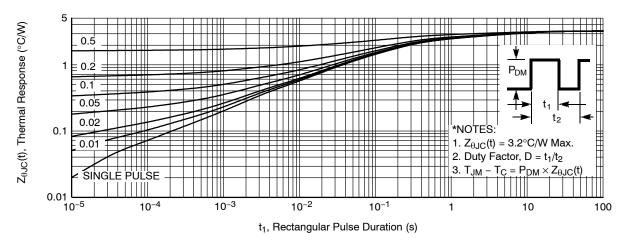


Figure 14. Transient Thermal Response Curve for FCPF190N60E

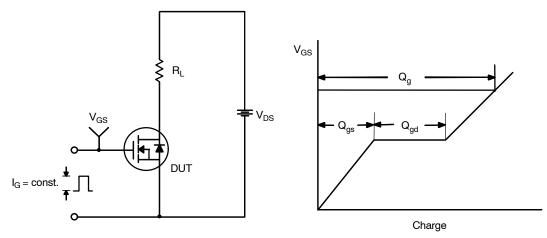


Figure 15. Gate Charge Test Circuit & Waveform

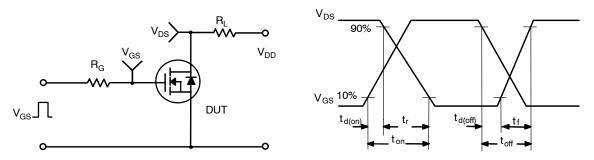


Figure 16. Resistive Switching Test Circuit & Waveforms

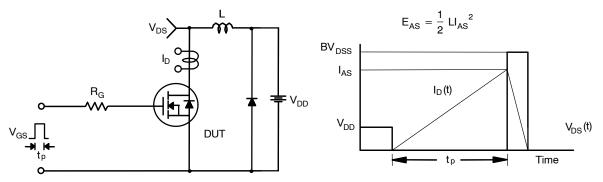


Figure 17. Unclamped Inductive Switching Test Circuit & Waveforms

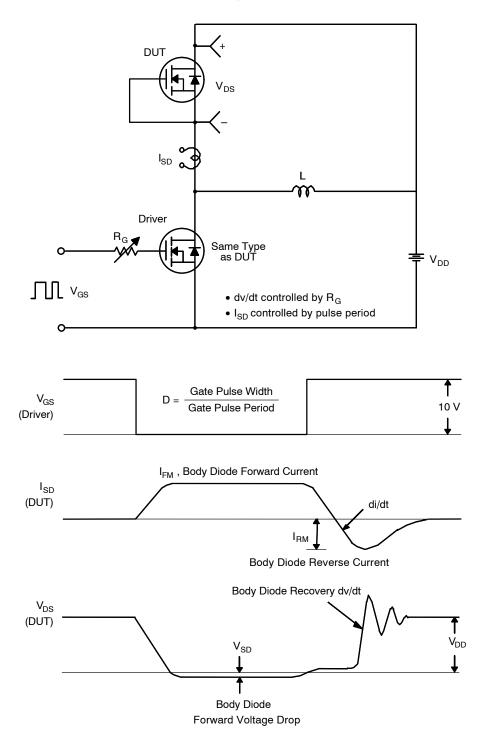
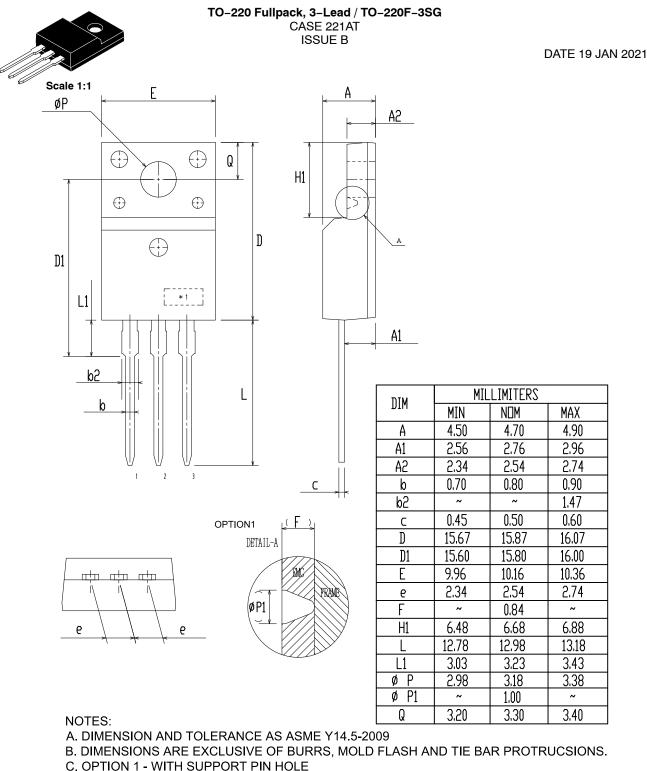


Figure 18. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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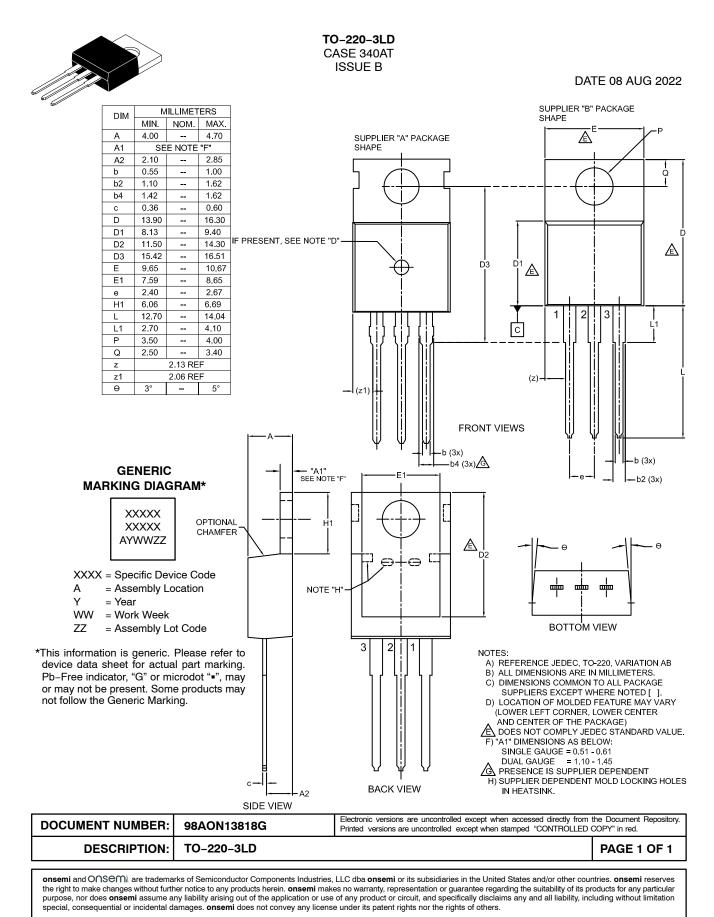


OPTION 2 - NO SUPPORT PIN HOLE

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